

# PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
<b>CONVEYING PARTY DATA</b>											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hiromasa Yamanashi</td> <td>02/26/2007</td> </tr> <tr> <td>Muneyuki Fukuda</td> <td>02/26/2007</td> </tr> <tr> <td>Sayaka Tanimoto</td> <td>02/21/2007</td> </tr> <tr> <td>Yasunari Sohda</td> <td>03/02/2007</td> </tr> </tbody> </table>		Name	Execution Date	Hiromasa Yamanashi	02/26/2007	Muneyuki Fukuda	02/26/2007	Sayaka Tanimoto	02/21/2007	Yasunari Sohda	03/02/2007
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<b>PROPERTY NUMBERS Total: 1</b>											
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<b>CORRESPONDENCE DATA</b>											
<p>Fax Number: (703)312-6666</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 7033126600</p> <p>Email: jaiken@antonelli.com</p> <p>Correspondent Name: Antonelli, Terry, Stout &amp; Kraus, LLP</p> <p>Address Line 1: 1300 N. 17th St.</p> <p>Address Line 2: Suite 1800</p> <p>Address Line 4: Arlington, VIRGINIA 22209</p>											
ATTORNEY DOCKET NUMBER:	520.47321X00										
NAME OF SUBMITTER:	Melvin Kraus										
<p>Total Attachments: 1</p> <p>source=assign#page1.tif</p>											

OP \$40.00 11687002

**500840083**

**PATENT**

**REEL: 022573 FRAME: 0061**

# ASSIGNMENT

( 譲渡証 )

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 1-24-14, Nishi Shinbashi, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

## Metrology System of Fine Pattern for Process Control by Charged Particle Beam

invented by me (if only one is named below ) or us (if plural inventors are named below ) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation.

Signed on the date(s) indicated aside signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) <u>Hiromasa Yamamashi</u> Hiromasa YAMANASHI	<u>2/26/2007</u>
2) <u>Muneyuki Fukuda</u> Muneyuki FUKUDA	<u>2/26/2007</u>
3) <u>Sayaka Tanimoto</u> Sayaka TANIMOTO	<u>2/21/2007</u>
4) <u>Yasunari Sohma</u> Yasunari SOHMA	<u>3/2/2007</u>
5) _____	_____
6) _____	_____
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____

PATENT

RECORDED: 04/21/2009

REEL: 022573 FRAME: 0062